

thereof, on the one hand, the smallest distance between the guide 5 and the cassette 1 can be very small, for example, approximately 1 mm, which enables the cassette 1 to be very accurately positioned, while on the other hand, the cassette 1 can still be very readily positioned in the holder 10. Due to this construction, in particular, the risk that the cassette 1 is obliquely positioned in the holder 10, i.e. tilted with respect to the base plate 3, is very small. If the cassette 1 is improperly positioned, a sensor 20, which is connected to the device will not be activated. By virtue of all the above aspects, the risk that the cassette 1 is improperly positioned, for example with respect to moving parts of an apparatus, not shown in the drawing, of which holder 10 forms part, is very small. Such an apparatus is, for example, an apparatus which is customarily used in the manufacture of semiconductor products, such as an etch apparatus or photoresist apparatus. By virtue of said accurate positioning, the risk of damage to the cassette 1 and, in particular, to the substrates 2 is very small. Consequently, in the manufacture of semiconductor products comprising a holder 10 in accordance with the invention, such as ICs (=Integrated Circuits), the percentage of rejects is low, leading to a substantial reduction of the cost price.

**IN THE CLAIMS:**

Please amend claim 1 as follows:

1. (Twice Amended) A holder for a cassette for semiconductor material substrates (2) comprising a base plate on which a guide member is provided with at least two guides is secured, which cassette can be arranged between the guides, which enable the cassette to be aligned with respect to the base plate, and a first side of the guide member which is facing away from the base plate is embodied to as to taper inwards,